

Photocouplers Photorelay

# **TLP3555**

### 1. Applications

- · Mechanical relay replacements
- · Security Systems
- · Measuring Equipment
- · Factory Automation (FA)
- · Amusement Equipment

#### 2. General

The TLP3555 photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 4-pin DIP package. The low ON-state resistance and the high permissible ON-state current of the the TLP3555 make it suitable for power line control applications.

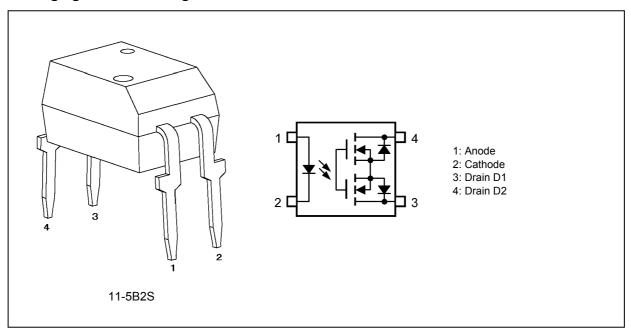
#### 3. Features

- (1) Normally open (1-Form-A)
- (2) OFF-state output terminal voltage: 60 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 2.0 A (max)
- (5) ON-state resistance:  $200 \text{ m}\Omega \text{ (max)}$
- (6) Isolation voltage: 2500 Vrms (min)
- (7) Safety standards

UL-under application: UL1577 File No.E67349

cUL-under application: CSA Component Acceptance Service No.5A, File No.E67349

#### 4. Packaging and Pin Configuration





#### 5. Internal Circuit

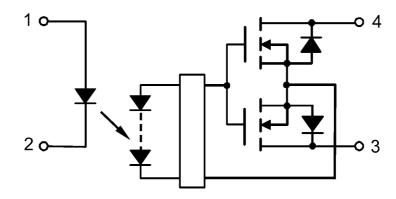


Fig. 5.1 Internal Circuit

### 6. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25°C)

	Characteristics	Symbol	Note	Rating	Unit	
LED	Input forward current		I <sub>F</sub>		30	mA
	Input forward current derating	$(T_a \ge 25^{\circ}C)$	$\Delta I_F/\Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 μs pulse, 100 pps)	I <sub>FP</sub>		1	Α
	Input reverse voltage		V <sub>R</sub>		5	V
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage		V <sub>OFF</sub>		60	V
	ON-state current		I <sub>ON</sub>		2	Α
	ON-state current derating	$(T_a \ge 25^{\circ}C)$	Δl <sub>ON</sub> /ΔT <sub>a</sub>		-20	mA/°C
	ON-state current (pulsed)	(t = 100 ms, Duty = 1/10)	I <sub>ONP</sub>		6	Α
	Junction temperature		Tj		125	°C
Common	Storage temperature		T <sub>stg</sub>		-55 to 125	
	Operating temperature		T <sub>opr</sub>		-40 to 85	
	Lead soldering temperature	(10 s)	T <sub>sol</sub>		260	
	Isolation voltage	AC, 1 min, R.H. ≤ 60%	BVS	(Note 1)	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

### 7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V <sub>DD</sub>		_	_	48	V
Input forward current	I <sub>F</sub>		5	10	25	mA
ON-state current	I <sub>ON</sub>		_	_	2	Α
Operating temperature	T <sub>opr</sub>		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.



# 8. Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25°C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V <sub>F</sub>		I <sub>F</sub> = 10 mA	1.18	1.33	1.48	V
	Input reverse current	I <sub>R</sub>		V <sub>R</sub> = 5 V	1		10	μА
	Input capacitance	Ct		V = 0 V, f = 1 MHz	1	70	_	pF
Detector	OFF-state current	I <sub>OFF</sub>		V <sub>OFF</sub> = 60 V	_	_	1	μА
	Output capacitance	C <sub>OFF</sub>		V = 0 V, f = 1 MHz	-	250	_	pF

# 9. Coupled Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>		I <sub>ON</sub> = 1.0 A	_	0.5	3	mA
Return LED current	I <sub>FC</sub>		I <sub>OFF</sub> = 10 μA	0.1			mA
ON-state resistance	R <sub>ON</sub>		$I_{ON} = 2.0 \text{ A}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	_	80	200	mΩ

# 10. Isolation Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	C <sub>S</sub>	(Note 1)	V <sub>S</sub> = 0 V, f = 1 MHz		0.8		pF
Isolation resistance	R <sub>S</sub>	(Note 1)	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5×10 <sup>10</sup>	1014		Ω
Isolation voltage	BVS		AC, 1 min	2500			Vrms
			AC, 1s in oil	_	5000	_	
			DC, 1 min, in oil	_	5000	-	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

# 11. Switching Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

Characteristics	Symbol	Note	Test Condition	Min	Тур	Max	Unit
Turn-on time	t <sub>ON</sub>		See Fig. 11.1.	_	0.8	5	ms
Turn-off time	t <sub>OFF</sub>		$R_L = 200 \Omega$ , $V_{DD} = 20 V$ , $I_F = 5 mA$	_	0.3	1	
Turn-on time	t <sub>ON</sub>		See Fig. 11.1.		0.4	3	
Turn-off time	t <sub>OFF</sub>		$R_L = 200 \Omega$ , $V_{DD} = 20 V$ , $I_F = 10 mA$		0.3	1	

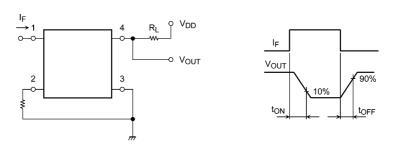


Fig. 11.1 Switching Time Test Circuit

#### 12. Characteristics Curves and Circuit Connections

### 12.1. Characteristics Curves (Note)

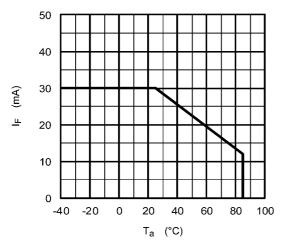


Fig. 12.1.1 I<sub>F</sub> - T<sub>a</sub>

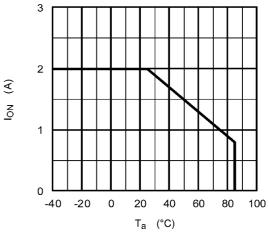


Fig. 12.1.2 I<sub>ON</sub> - T<sub>a</sub>

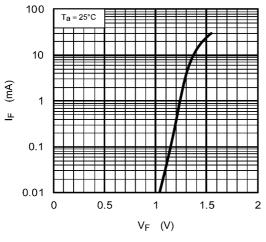


Fig. 12.1.3 I<sub>F</sub> - V<sub>F</sub>

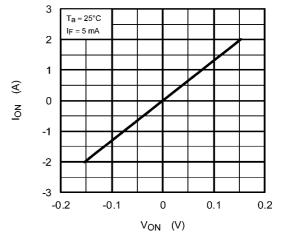


Fig. 12.1.4 I<sub>ON</sub> - V<sub>ON</sub>

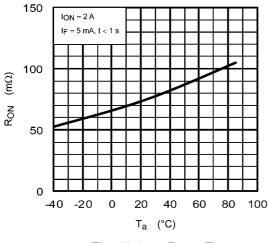


Fig. 12.1.5 R<sub>ON</sub> - T<sub>a</sub>

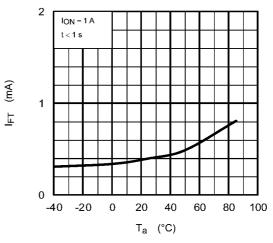


Fig. 12.1.6  $I_{FT}$  -  $T_a$ 

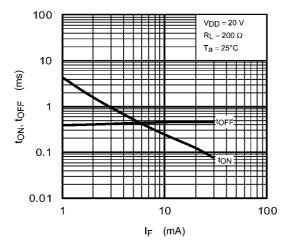


Fig. 12.1.7  $t_{on}$ ,  $t_{off}$  -  $I_F$ 

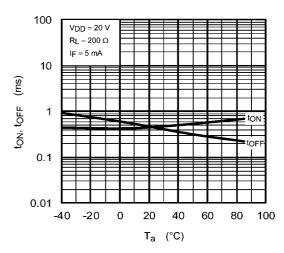


Fig. 12.1.8 t<sub>on</sub>, t<sub>off</sub> - T<sub>a</sub>

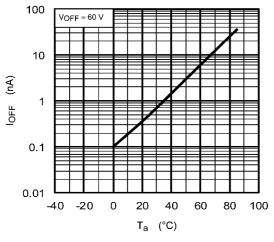


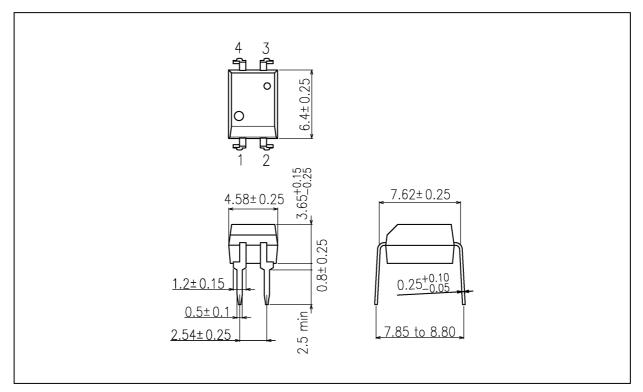
Fig. 12.1.9 I<sub>OFF</sub> - T<sub>a</sub>

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



# **Package Dimensions**

Unit: mm



Weight: 0.26 g (typ.)

	Package Name(s)
TOSHIBA: 11-5B2S	

Rev.3.0



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